Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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NPN SILICON RF TRANSISTOR 2SC5011

NPN EPITAXIAL SILICON RF TRANSISTOR FOR HIGH-FREQUENCY LOW-NOISE AMPLIFICATION 4-PIN SUPER MINIMOLD

FEATURES

- High Gain Bandwidth Product ($f_T = 6.5 \text{ GHz TYP.}$)
- · Low Noise, High Gain
- Low Voltage Operation
- · 4-pin super minimold Package

★ ORDERING INFORMATION

Part Number	Quantity	Supplying Form
2SC5011	50 pcs (Non reel)	• 8 mm wide embossed taping
2SC5011-T1	3 kpcs/reel	Pin 3 (Base), Pin 4 (Emitter) face to perforation side of the tape

Remark To order evaluation samples, contact your nearby sales office.

The unit sample quantity is 50 pcs.

ABSOLUTE MAXIMUM RATINGS ($T_A = +25$ °C)

Parameter	Symbol	Ratings	Unit
Collector to Base Voltage	Vcво	20	V
Collector to Emitter Voltage	VCEO	12	V
Emitter to Base Voltage	V _{EBO}	3	V
Collector Current	lc	100	mA
Total Power Dissipation	Ptot Note	150	mW
Junction Temperature	Tj	150	°C
Storage Temperature	T _{stg}	-65 to +150	°C

Note Free air

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

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ELECTRICAL CHARACTERISTICS (TA = +25°C)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit	
DC Characteristics							
Collector Cut-off Current	Ісво	VcB = 10 V, IE = 0 mA	-	_	1.0	μΑ	
Emitter Cut-off Current	Ієво	V _{EB} = 1 V, I _C = 0 mA	-	-	1.0	μΑ	
DC Current Gain	hfe Note 1	VcE = 10 V, Ic = 20 mA	50	120	250	-	
RF Characteristics							
Gain Bandwidth Product	f⊤	VcE = 10 V, Ic = 20 mA	-	6.5	-	GHz	
Insertion Power Gain	S _{21e} ²	VcE = 10 V, Ic = 20 mA, f = 1.0 GHz	11	13	-	dB	
Noise Figure	NF	VcE = 10 V, Ic = 7 mA, f = 1.0 GHz	-	1.1	2.0	dB	
Reverse Transfer Capacitance	Cre Note 2	VcB = 10 V, IE = 0 mA, f = 1.0 MHz	-	0.5	0.9	pF	

Notes 1. Pulse measurement: PW \leq 350 μ s, Duty Cycle \leq 2%

2. Collector to base capacitance when the emitter grounded

hfe CLASSIFICATION

Rank	EB	FB	GB
Marking	R26	R27	R28
h _{FE} Value	50 to 100	80 to 160	125 to 250

2

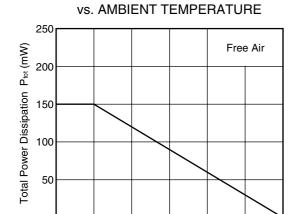


0

25

50

TYPICAL CHARACTERISTICS (TA = +25°C, unless otherwise specified)



TOTAL POWER DISSIPATION

COLLECTOR CURRENT vs. BASE TO EMITTER VOLTAGE

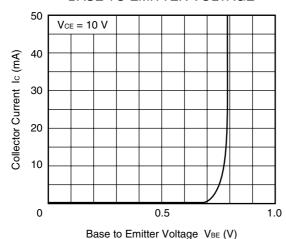
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Ambient Temperature TA (°C)

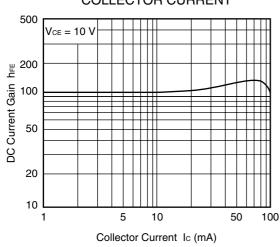
100

125

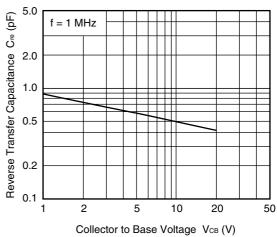
150



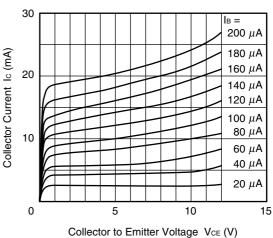
DC CURRENT GAIN vs. COLLECTOR CURRENT



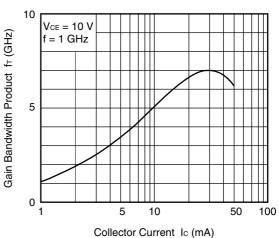
REVERSE TRANSFER CAPACITANCE vs. COLLECTOR TO BASE VOLTAGE



COLLECTOR CURRENT vs.
COLLECTOR TO EMITTER VOLTAGE



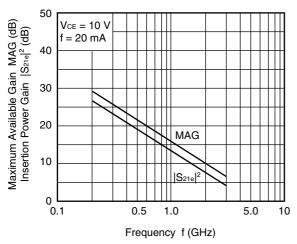
GAIN BANDWIDTH PRODUCT vs. COLLECTOR CURRENT



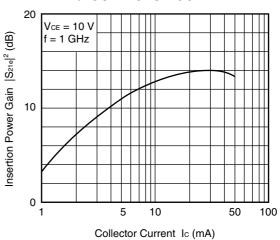
Remark The graphs indicate nominal characteristics.



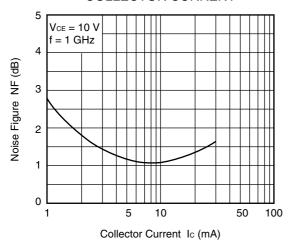
MAXIMUM AVAILABLE GAIN/INSERTION POWER GAIN vs. FREQUENCY



INSERTION POWER GAIN vs. COLLECTOR CURRENT



NOISE FIGURE vs. COLLECTOR CURRENT



Remark The graphs indicate nominal characteristics.

★ S-PARAMETERS

S-parameters/Noise parameters are provided on the NEC Compound Semiconductor Devices Web site in a form (S2P) that enables direct import to a microwave circuit simulator without keyboard input.

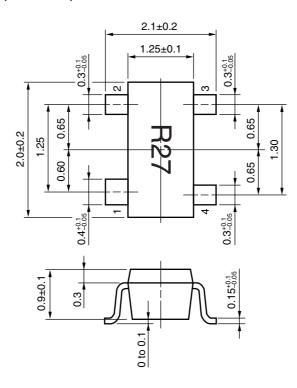
Click here to download S-parameters.

 $[\mathsf{RF} \ \mathsf{and} \ \mathsf{Microwave}] \to [\mathsf{Device} \ \mathsf{Parameters}]$

URL http://www.ncsd.necel.com/

★ PACKAGE DIMENSIONS

4-PIN SUPER MINIMOLD (UNIT: mm)



PIN CONNECTIONS

- 1. Collector
- 2. Emitter
- 3. Base
- 4. Emitter

5

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M8E 00.4-0110

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